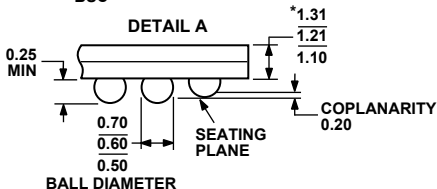
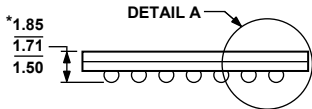
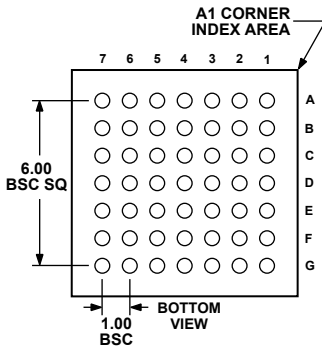
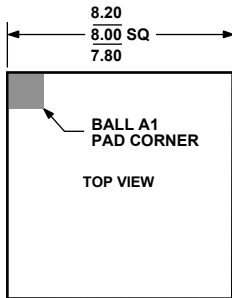


**49-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-49-3)**

Dimensions shown in millimeters



*COMPLIANT WITH JEDEC STANDARDS MO-192-ABB-1
WITH EXCEPTION TO PACKAGE HEIGHT AND THICKNESS.